


STP4407 
M MOSFET
- 10A

P C E

DESCRIPTION

T STP4407 P-C

STP4407

ELECTRICAL CHARACTERISTICS ($T = 25^{\circ}\text{C}$ U)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
D B	-S V	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\text{ A}$	-30		V
G V	T	$V_{GS()}$	$V_{DS}=V_{GS}, I_D=-250\text{ A}$	-1.0	-2.5	V
G	L C	I_{GSS}	$V_{DS}=0V, V_{GS}= 20V$		100	A
D C	G V	I_{DSS} $T_J=55^{\circ}\text{C}$	$V_{DS}=-30V, V_{GS}=0V$		-1	A
			$3V_{DS}=-30V, V_{GS}=0V$		-5	
D R	- O -	$R_{DS()}$	$V_{GS}=-10V, I_D=-10A$ $V_{GS}=-4.5V, I_D=-6.0A$	15 24	20 32	Ω
F T			$V_{DS}=-5V, I_D=-10A$	26		S

D F V V_{SD} $I_S=-19\text{ A}$ 9.84 A 0.0 A 9.84 A 0.0 A 8.219 A 9.84 A () $0.490.048$

TYPICAL CHARACTERISTICS

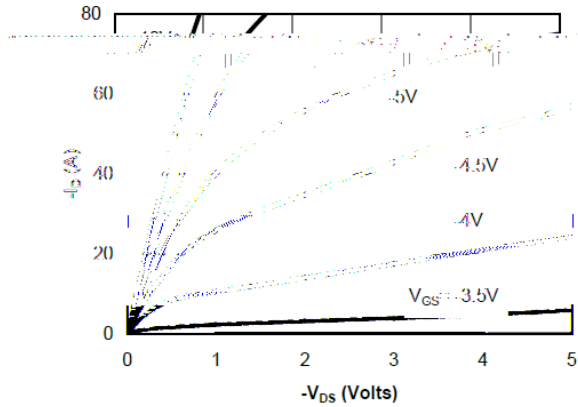


Figure 1: On-Region Characteristics

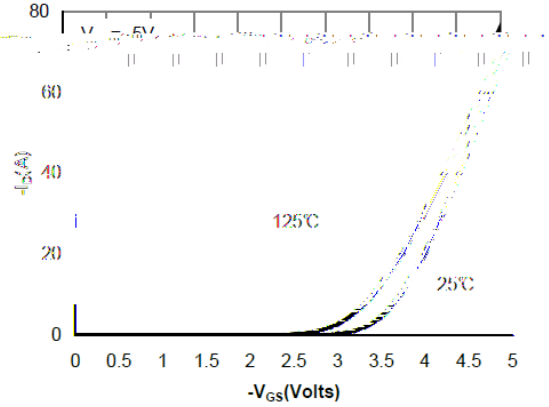


Figure 2: Transfer Characteristics

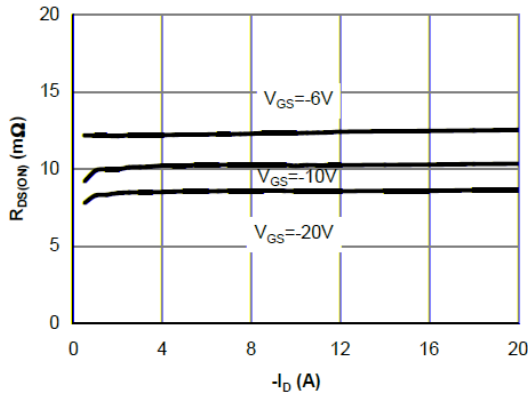


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

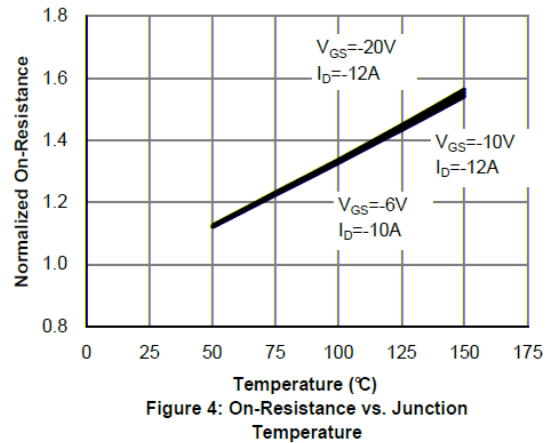


Figure 4: On-Resistance vs. Junction Temperature

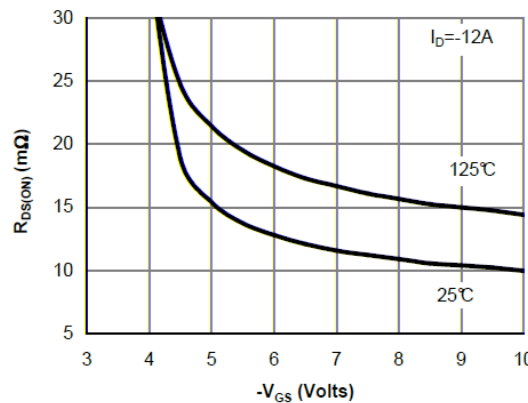


Figure 5: On-Resistance vs. Gate-Source Voltage

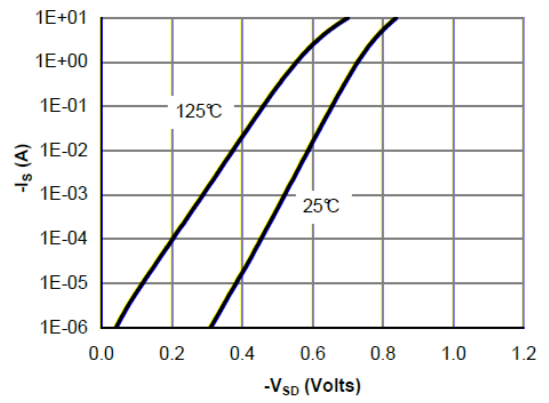


Figure 6: Drain-Source Current vs. Drain-Source Voltage

TYPICAL CHARACTERISTICS

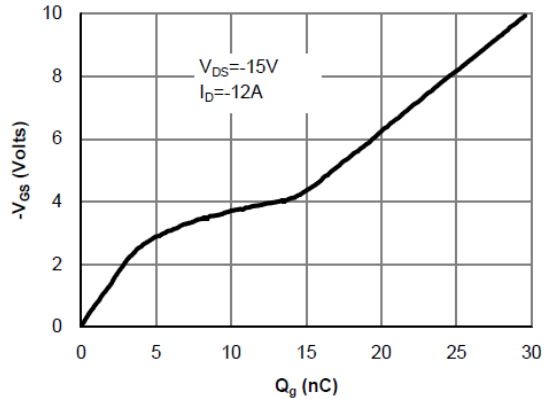


Figure 7: Gate-Charge Characteristics

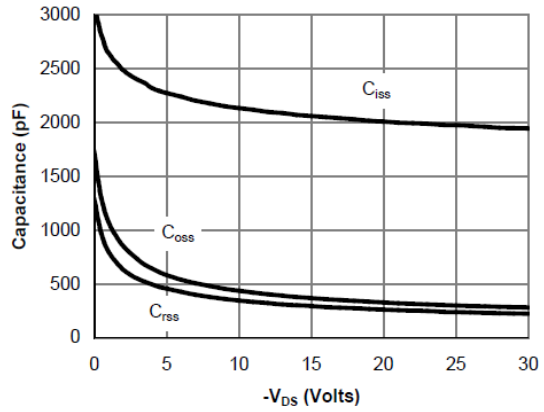


Figure 8: Capacitance Characteristics

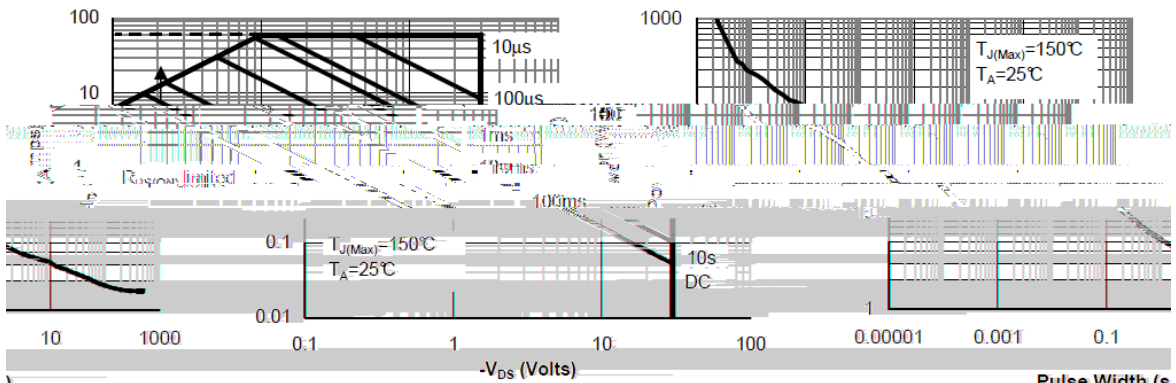


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

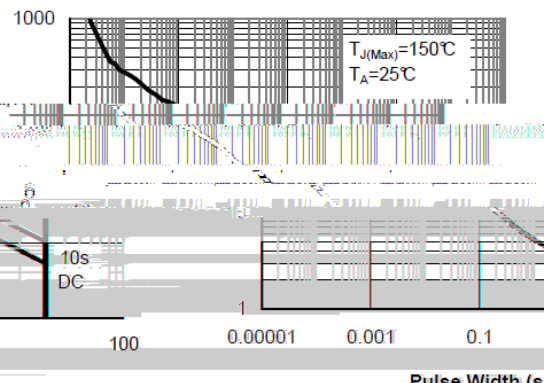


Figure 10: Single Pulse Power to-Ambient (Note E)

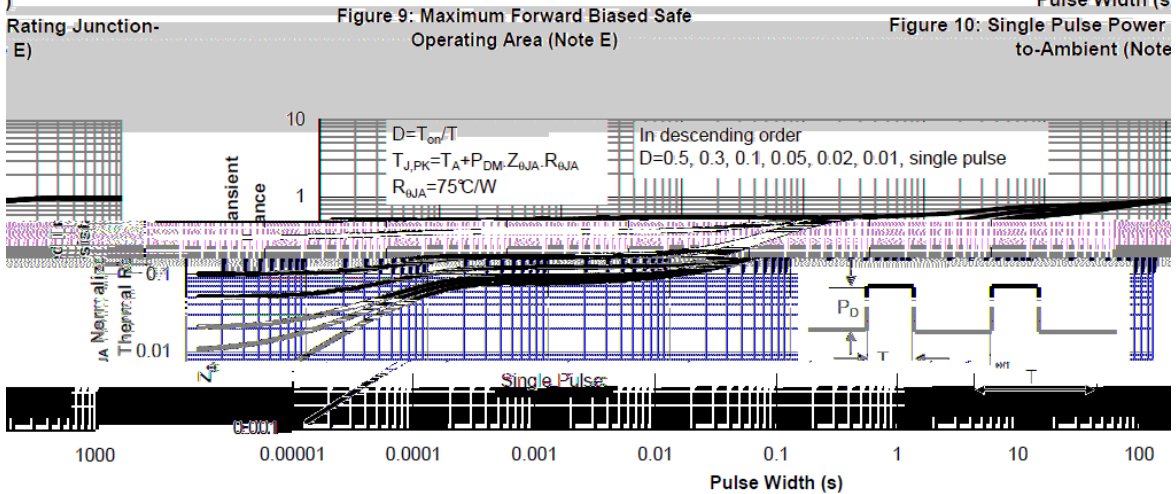
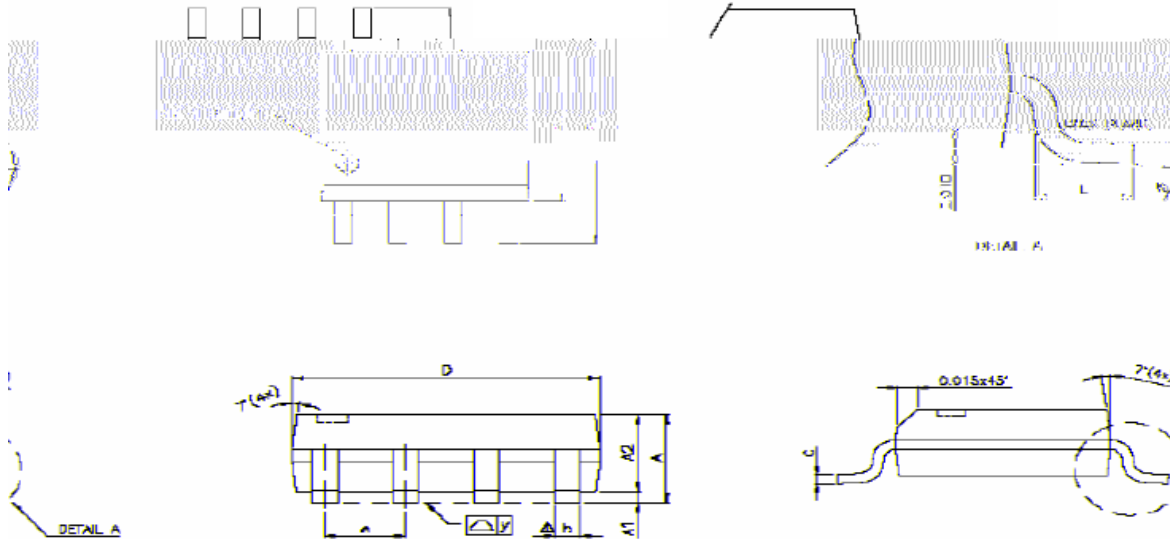


Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)

PACKAGE OUTLINE SOP-8P



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.47	1.60	1.73	0.058	0.063	0.069
A2	—	—	—	1.25	—	—
b	0.038	—	—	0.001	—	—
c	0.119	—	—	0.004	—	—
D	4.83	—	—	0.190	—	—
e	—	—	—	—	—	—
E	0.050	—	—	—	—	—
0.015	0.028	0.050	—	—	—	—
—	—	0.003	—	—	—	—
0°	—	8°	—	—	—	—
s	—	—	—	—	1.27	—
L	0.38	0.71	1.27	—	—	—
y	—	—	0.076	—	—	—
0°	—	—	8°	—	—	—